

# 广州市东裕光电科技有限公司

# 产品规格书SPECIFICATION

客户名称 CUSTOMER	
产品名称 PRODUCTION	红外发射管贴片 SMD InfraRed Emitting Diode
产品型号 MODEL	DYWH-IR19-21C/TR8
版本号 VERSION NO	A1.0

地址(Add): 深圳市光明区凤凰街道光明大道 481 号乐府广场 1B 栋 1609-1611 室

厂址(Add): 广东省广州市番禺区石基镇海涌路 3 号 10 号厂房 2 楼

电话(Tel): 18038161512

传真(Fax): 020-39966833

网址(Net): www.tonyuled.com www.tonyuled.com

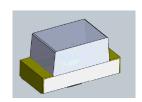




客户确认	审 核	编 制		
CUSTOMER CONFIRMATION	CHECKED BY	PREPARED BY		
	周毅兴	陈少龙		



## **DYWH-IR19-21C/TR8**



#### 产品描述 Descriptions

- 红外发光二极管(DYWH-IR19-21C/TR8)是一种高辐射强度的二极管,模制在一个透明的塑料封装中。 (This Infrared Emitting Diode is a high intensity diode, molded in a clear plastic package.)
- 可适配光敏三极管、光敏二极管、红外接收头、红外接收模块等。 (The device is spectrally matched with phototransistor, photodiode and infrared receiver module.)

#### 产品特性 Features

峰值波长 λ p=940nm (Peak wavelength λ p=940nm)

• SMD LED (SMD LED)

● 适用于自动贴片机 (Compatible With SMT Automatic Equipment)

● 适用于红外线回流焊制程 (Compatible With Infrared Reflow Solder Process)

● 低功耗 (Low forward voltage)

● 无铅 (Pb free)

● 符合 RoHS 要求 (This product itself will remain within RoHS compliant version)

## 产品应用 Applications

● 遥控器 (Remote control)

● 自由空气传输系统 (Free air transmission system)

● 烟感 (Smoke detector)

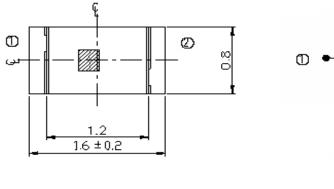
● 红外应用系统 (Infrared applied system)

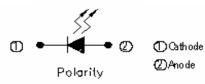
#### 包装方式 Packing Quantity Specification

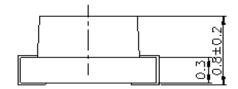
● 编带 4000 个/卷 (4000PCS/rolls)



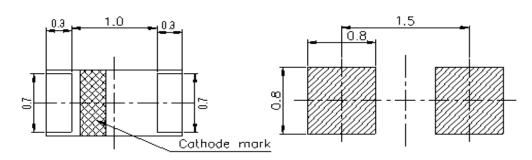
#### 一、外形图 Outline dimensions:







For reflow soldering (Propose)



Notes: 1. All dimensions are in mm, tolerance is  $\pm 0.15$  unless otherwise noted.

单位	公差	芯片材料	发光颜色	胶体颜色
Unit	Tolerance	Die material	Emission color	Lens color
mm	±0.15mm	GaAlAs	_	Water Clear

※备注:承认书之编号和型号可用于查询,客户如有需要,请提供相应的编号和型号。

Remark: P/N & Model in samples approval sheet can be used to inquire, please provide corresponding P/N & model if customer need.



## 二、光电参数 Electro-Optical Characteristics:

(环境温度 Ambient temperature: 25℃, 环境湿度 Humidity: RH60%)

项目 Item	符号 Symbol	测试条件 Test condition	最小值 Min.	典型值 Type	最大值 Max	单位 Unit.
正向电压 Forward voltage	VF	IF=20mA	-	1.2	1.5	V
反向电流 Reverse current	IR	VR=5V	-	-	10	μА
辐射强度 Radiant intensity	Ee	IF=20mA	0.2	0.7	-	mW/sr
光谱半值宽 Spectral band width	Δλ	IF=20mA	-	50	-	nm
峰值波长 Peak wavelength	λр	IF=20mA	-	940	-	nm
视 角 Viewing Angle	201/2	IF=20mA	-	150	-	deg

Notes): \*正向电压公差范围(Forward voltage tolerance): ±0.1v \*辐射强度公差范围 Radiant intensity tolerance): ±10%

\*波长公差范围(wavelength tolerance): ±1.0nm



#### 三、典型光电特性曲线图 Typical photoelectricity characteristic curve chart:

Fig.1 Forward Current vs. **Ambient Temperature** 140 120 100 Forward Current (mA) 80 60 40 20 0 40 60 80 100 -25 20 Ambient Temperature (° C)

Fig.2 Spectral Distribution

Fig.3 Forward Current vs

Forward Voltage

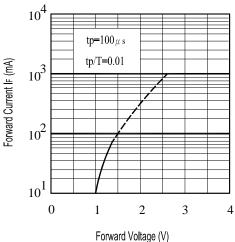


Fig.4 Relative Intensity vs.

Wavelength  $\lambda$  (nm)

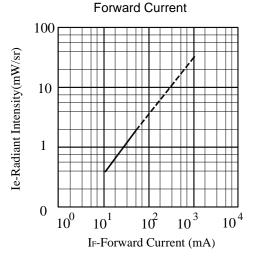
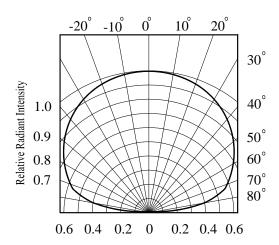


Fig.5 Relative Radiant Intensity vs.

Angular Displacement





## 四、极限参数 Absolute Maximum Rating:

(环境温度 Ambient temperature: 25℃, 环境湿度 Humidity: RH60%)

项目	符号	数值	单位	
Item	Symbol	Value	Unit	Remark
正向电流	IF	65	A	
Forward Current	IΓ	03	mA	<del></del>
反向耐压	VR	5	V	
Reverse Voltage	VK	3	V	<del></del>
耗散功率	Pd	120	mW	
Power Dissipation	Pa	130	III VV	<del></del>
工作环境温度	Tamb	-40 至+85	°C	
Operation temperature	Tallio	-40 土+63		<del></del>
贮藏温度	Tata	-40 至+100	$^{\circ}\mathrm{C}$	
Storage temperature	Tstg	<del>-4</del> 0 土+100	-C	<del></del>
焊接温度*2	Ta a 1	260	°C	回流焊 Reflow soldering: 260 ℃ for 5 sec.
Soldering temperature	Tsol	260	°C	手工焊 Hand soldering: 300°C for 3 sec.

Notes\*1: IFP Conditions-Pulse Width $\!\leq\!100\mu s$  and Duty $\!\leq\!1\%$ 

\*2: Solding time  $\leq$ 5 seconds.

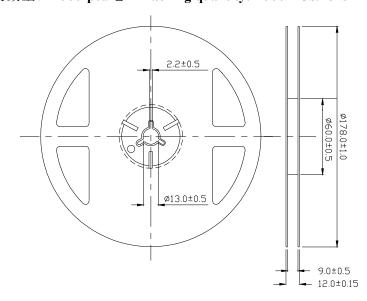
## 五、可靠性实验项目 Reliability Test Project:

描述	项目	测试标准	测试条件	测试时间	数量	失效数量
Description	Item	Test criterion	Test condition	Test time	Qty.	Fail Qty.
寿命测试	常温寿命测试	JIS7021:B4	Ta=25°C±5°C,IF=20mA	1000Hrs	22	0
Ambience test  冷热冲击测试 Cold / Heat strike test  冷热循环测试	高温存储	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	Ta=85°C±5°C	1000Hrs	22	0
		JIS7021:B12	Ta= -35°C±5°C	1000Hrs	22	0
	高温高湿测试 High temperature/ humidity test	JIS7021:B11 MIL-STD-202:103D	Ta=85°C±5°C RH=85%	1000Hrs	22	0
		JIS7021:B4 MIL-STD-202:107D MIL-STD-750:1026	30min -10°C±5°C←→100°C±5°C 5min 5min	50Cycles	22	0
	冷热循环测试 Cold and heat cycle test	JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E	5min 5min 5min -35°C~25°C~85°C~-35°C 30min 5min 30min 5min	50Cycles	22	0

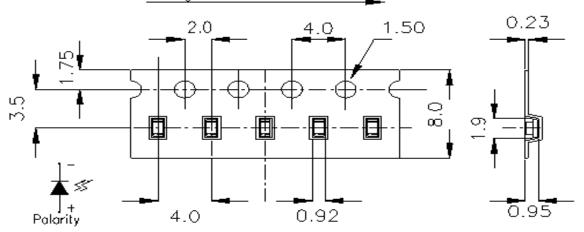


## 六、包装方式 Package Bag Dimensions

包装数量: 4000 pcs/卷 Packing quantity: 4000 PCS/rolls



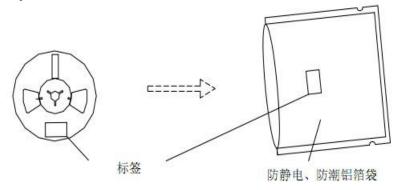
#### Progressive direction,



注: 所有尺寸均为毫米,除非另有说明,公差为±0.1。

Notes: All dimensions are in mm, tolerance is  $\pm 0.1$  unless otherwise noted.

## 标签及标识/ Label Explanation:



The label

Anti-static, moisture-proof aluminum foil bag



#### 七、失效判定标准 Criteria For Judging Damage

Test Items 项目	Symbol 符号	Test Condition	Judging For Damage 判定标准		
<b>以</b> 日	14.2	测试条件	Min. 最小	Max. 最大	
Forward Voltage 正向电压	VF	IF=20mA		U.L*x1.1	
Reverse Current 反向电流	IR	VR = 5V		U.L*x2.0	
Radiant intensity 辐射强度	Ee	IF=20mA	L.L*x0.7		

U.L: Upper standard level 规格Max L.L: Lower standard level 规格Min

# 八、使用注意事项 Precautions For Use

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

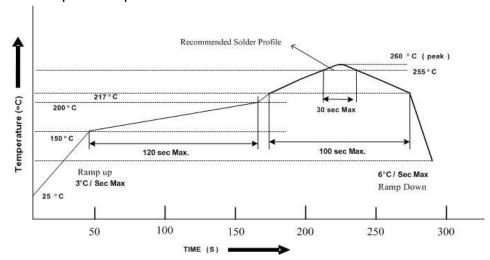
#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 After opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and  $60^{\circ}$ RH or less.
- 2.3 The LEDs should be used within 168 hours (7days) after opening the package.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 24 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile





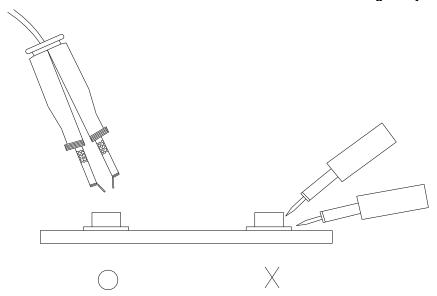
- 3.2 Reflow soldering should not be done more than two times
- 3.3 When soldering, do not put stress on the LEDs during heating
- 3.4 After soldering, do not warp the circuit board

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



## 九、免责声明 DISCLAIMER

- 1. TONYU reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets TONYU published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. TONYU assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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